

BONDERITE®



CONDUCTIVE COATINGS: ENABLING DRY BATTERY CELL MANUFACTURING

AUTHORS: DR. TOBIAS KNECHT, DR. JACOB TURNER, KIRK KRAMER



Henkel Adhesive Technologies

WELCOME!



Dr. Jacob Turner
Senior Chemist, Henkel

HOW DO CONDUCTIVE ELECTRODE COATINGS OPTIMIZE THE PERFORMANCE OF DRY COATED BATTERIES?

HENKEL ADHESIVE TECHNOLOGIES

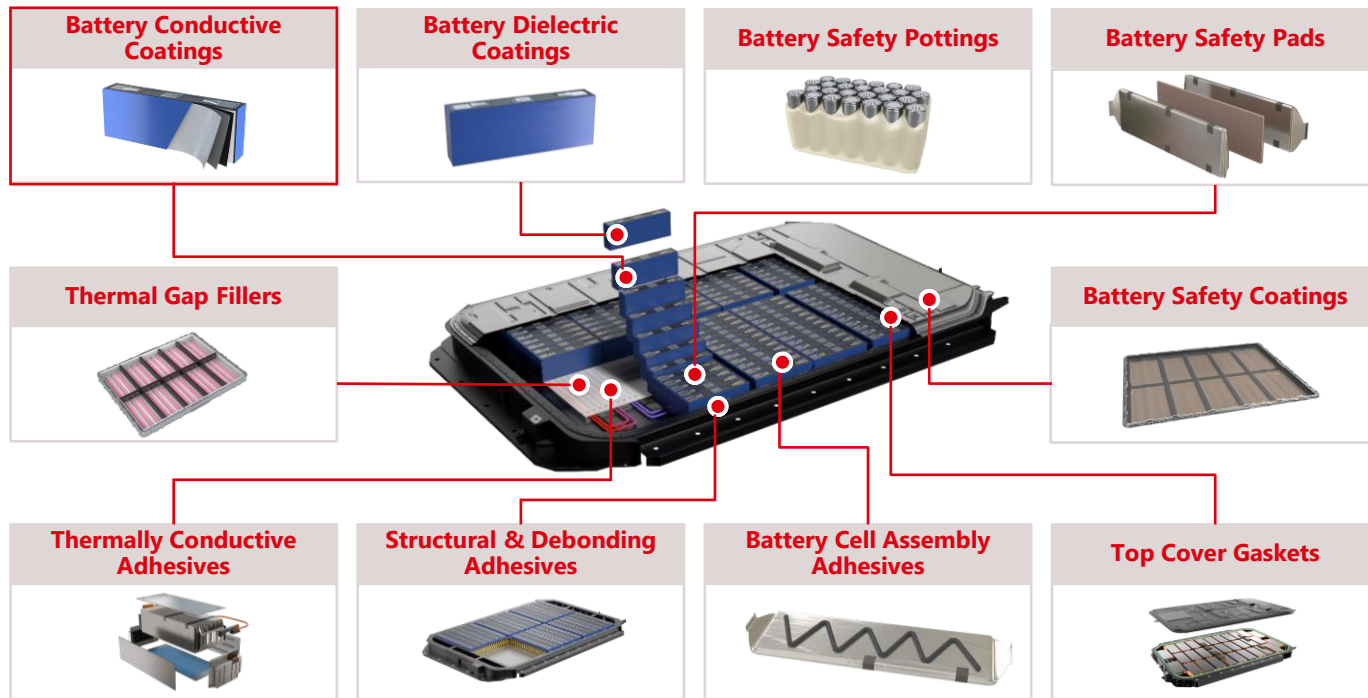
THE **BAT**TERY SHOW
NORTH AMERICA

DR. JACOB TURNER, SR. CHEMIST
THE BATTERY SHOW | OCT. 8, 2024



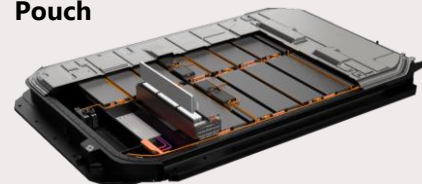
HENKEL E-MOBILITY SOLUTIONS

KEY TECHNOLOGIES FOR BATTERY SYSTEMS



APPLICABLE TO VARIOUS BATTERY TYPES

Pouch



Cylindrical



Prismatic



AUTOMOTIVE COMPONENTS BUSINESS

GLOBAL FOOTPRINT

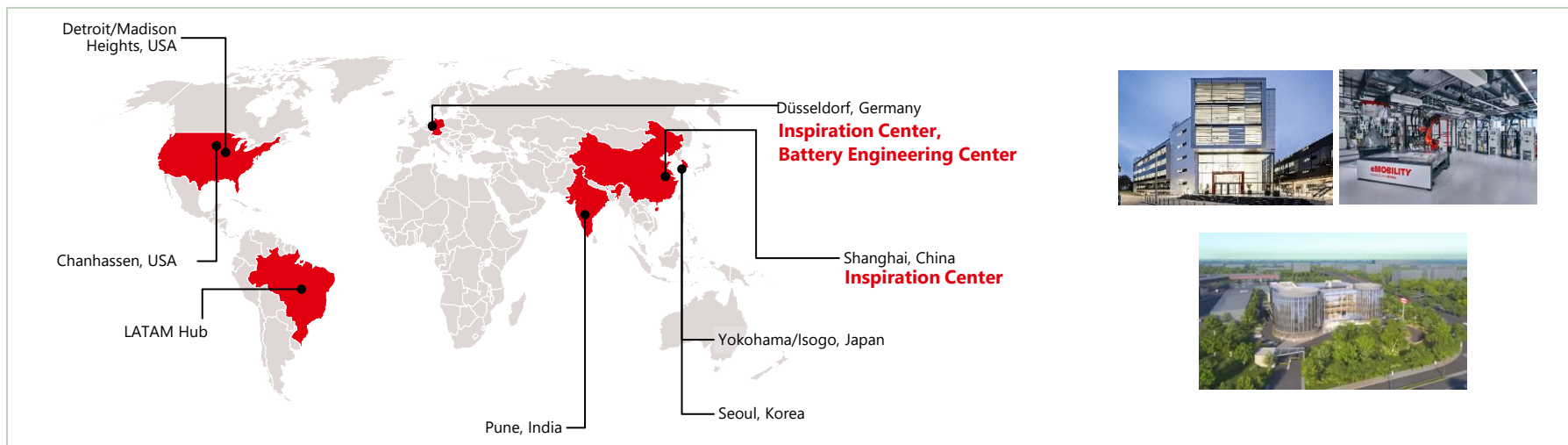
8 Innovation Hubs
**Automotive
Expertise**

~200 Scientists
**Multi-
Technologies**

~100 Thermal &
**Battery
Solutions Experts**

~400* Patents
**Automotive
Applications**

+200M€ Invest
**Inspiration Centers
Düsseldorf/Shanghai**



* Active patent families

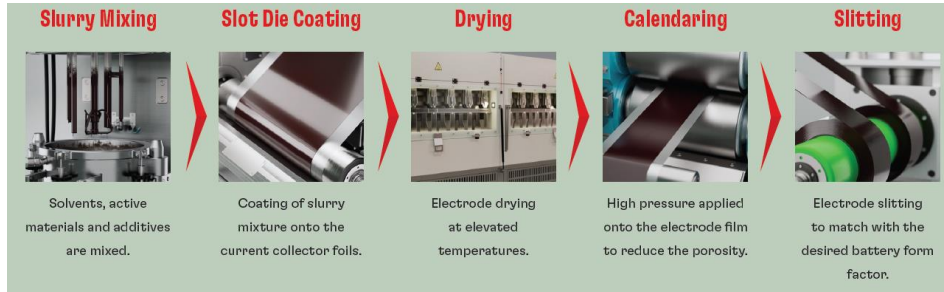


ELECTRODE MANUFACTURING WET VS. DRY COATING

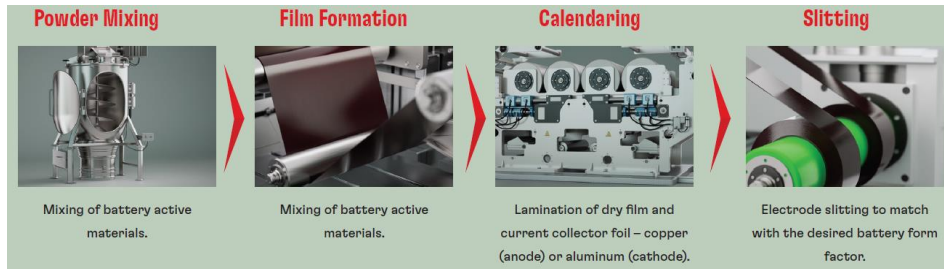


ELECTRODE MANUFACTURING | WET & DRY PROCESS

Wet process



Dry process



Factory layout

-20% reduction in production footprint



No use of NMP

No drying and solvent recovery



CAPEX

-35% reduction in manufacturing invest



Energy and CO₂

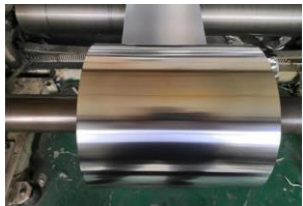
-30% reduction in energy demand



Performance

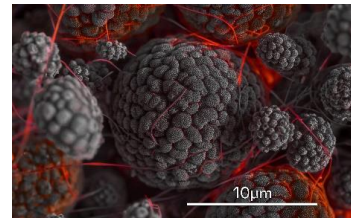
Thick electrodes and ASSB possible

DRY ELECTRODE MANUFACTURING | CHALLENGES



No adhesion between dry film and current collector foil

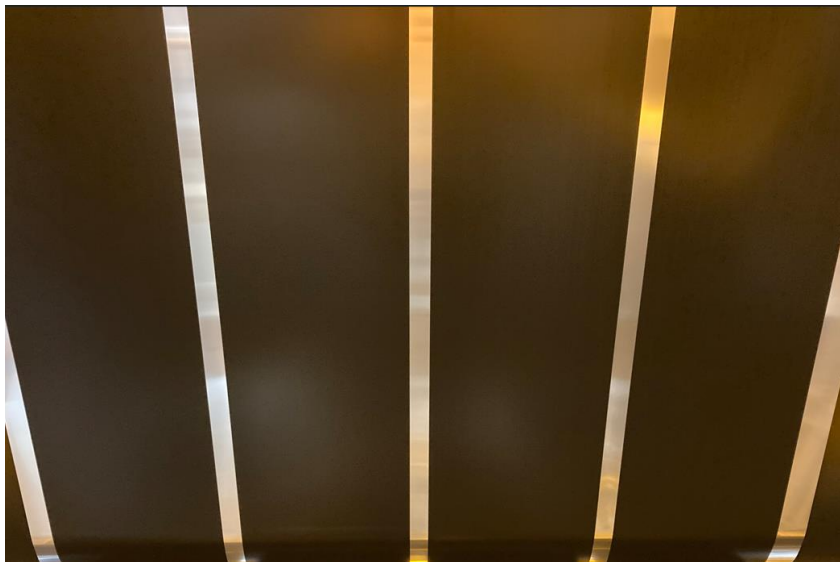
⚡ Resistance rise, capacity fading, processing issues, ...



- Dry film typically consists of active materials, carbon additives and fibrillized PTFE.
- In contrast to wet processing, binder cannot interact with aluminum or copper foil surface.

Current collector foil surface modification required!

CONDUCTIVE ELECTRODE COATING FOR THE BEST INTERFACIAL MATERIAL CONTACT



PHYSICAL ADHESION PROMOTION

- Increased affinity & contact area



ELECTRICAL ENHANCED CONDUCTIVITY

- Increased conduction channels

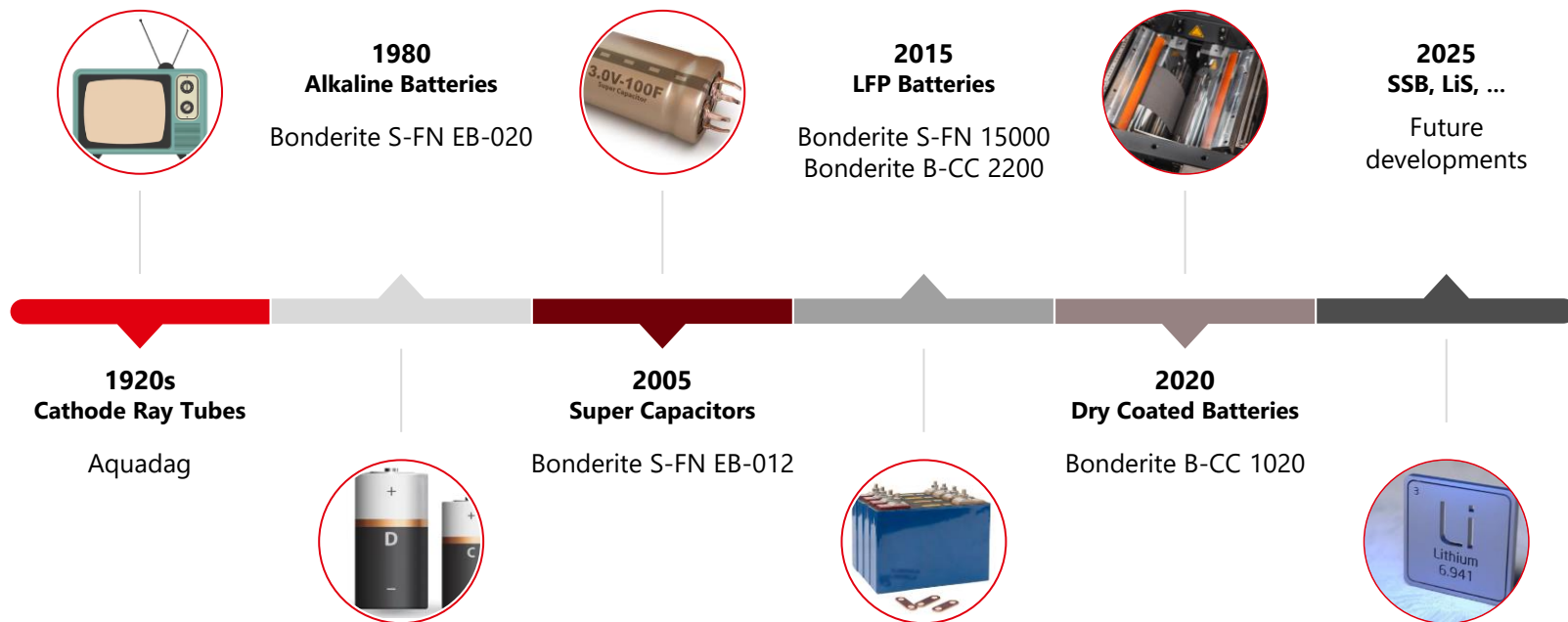


ELECTROCHEMICAL ANTI-CORROSION

- Reduced oxidation & dissolution

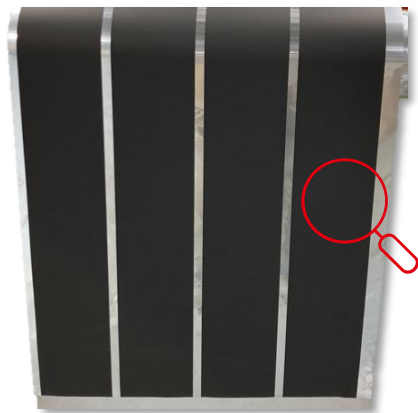
HENKEL'S CONDUCTIVE COATING LEGACY

Trusted partner in tailored carbon coatings for >100 years

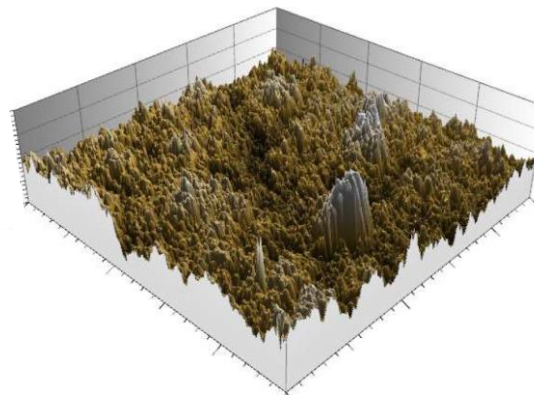


CONDUCTIVE COATINGS | GENERAL UNDERSTANDING

Conductive coatings:
Dispersions of carbons and resin on metal foils



Surface view



ADHESION PROMOTION | WET ELECTRODE PROCESSING

Carbon coated foil

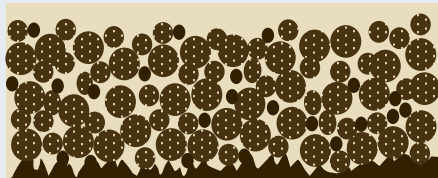
Slot-die coating

Drying



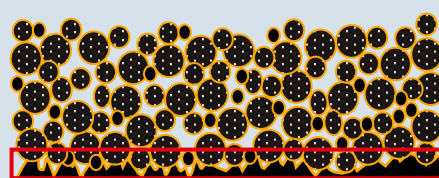
Current Collector

Carbon coated copper or aluminum foils as substrate for anode / cathode manufacturing.



Current Collector

Slot-die coating of dispersed active materials, carbons and binder onto the current collector.



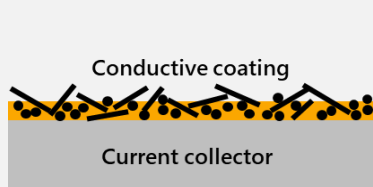
Current Collector

Improved adhesion and conductivity between current collector and active materials through conductive coating.



DRY BATTERY PROCESSING | HENKEL'S "ACTIVE" COATING CONCEPT

"Passive" conductive coating systems



Film application

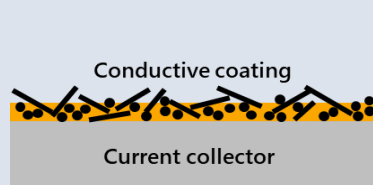


Calendering



Dry film forced to adapt to conductive coating

Henkel's "active" conductive coating systems



Film application



Calendering



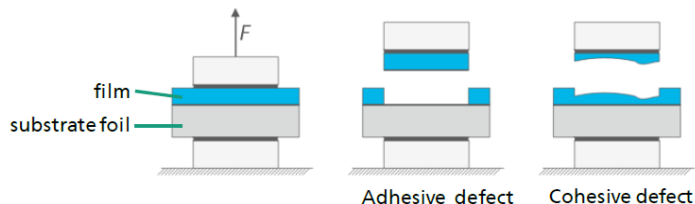
Conductive coating designed to adapt to dry film

TECHNICAL INSIGHTS

ADHESION CHARACTERISTICS

Dry electrode sheet production and validation with Henkel BCCs

Stamp pull-off test



Technical Information



Electrode chemistry

Dry Electrode:

CAM: 95wt% NMC 622

Carbon: 4wt% Super C65

Binder: 1wt% PTFE

Loading: 30 mg/cm²

Carbon coatings:

Active coating: Bonderite B-CC 1020

Passive coating: Reference material



Process conditions calendar

Temperature variation:

Pressure: 40 kN

Temperature:

RT, 50, 80, 110, 130 °C

Pressure variation:

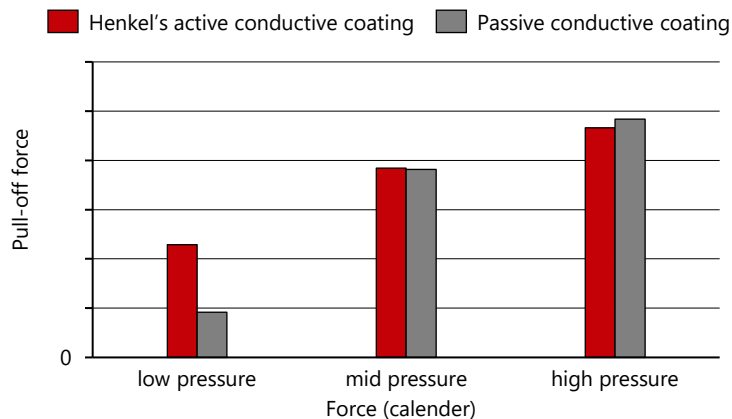
Temperature: 110 °C

Pressure: 40, 80, 120 kN

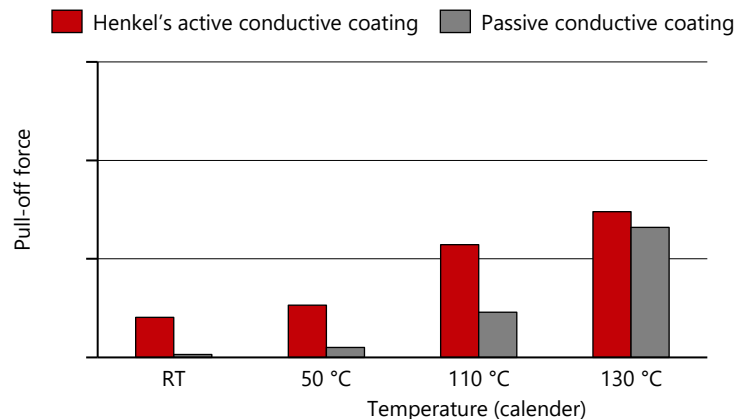
TECHNICAL INSIGHTS & HENKEL'S BENEFIT

ADHESION CHARACTERISTICS OF DRY COATED ELECTRODE

Lamination pressure variation



Lamination temperature variation

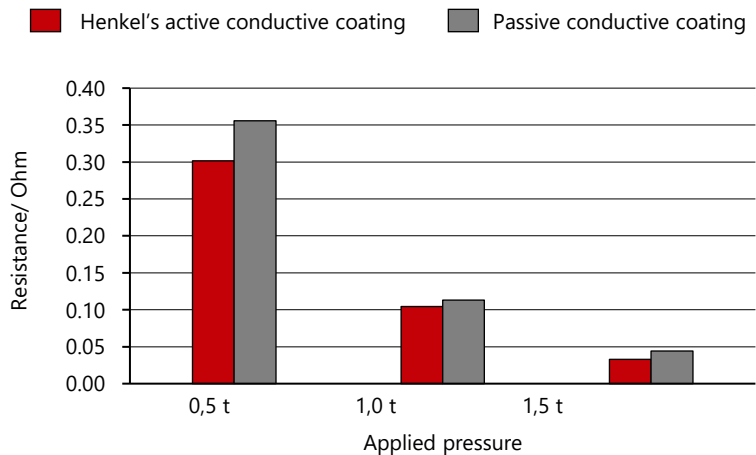


- Henkel active coating systems show cohesive failures for all temperature and pressure conditions
- Passive coating systems lead to adhesive defects at low temperatures
- **Positive effects: Milder processing conditions, reduced energy demand, improved cycle life & cell performance**

PERFORMANCE & SUMMARY

RESISTANCE & INTERFACE CHARACTERISTICS

Pressure dependent DC resistance



💡 Key learnings



Henkel conductive coatings enable reliable adhesion for wet and dry coated battery cells.



Conductive coatings can reduce the cell resistance and increase battery performance and lifetime.





Dry battery electrode manufacturing can reduce CAPEX and OPEX in cell manufacturing.



The omission of NMP in dry battery production reduces toxic solvent and energy demand.



CORE HENKEL PRODUCT PORTFOLIO

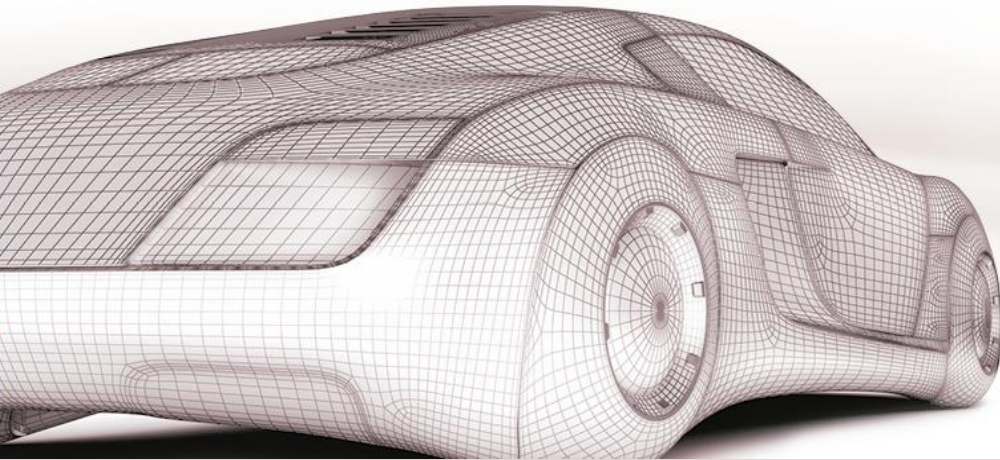
ENERGY STORAGE MARKET

| | | DBE Processing BONDERITE B-CC 1020  | Wet Processing BONDERITE B-CC 2200  | OTHER BONDERITE S-FN EB-012 |
|-------------------------|--|--|--|---------------------------------------|
| Formulation | Solvent | Water | Water | Water |
| | Electrode | Cathode & Anode | Cathode | Cathode & Anode |
| | Active materials | Any | LFP | Any |
| | Cell design | Any | Any | Any |
| Application | Application technology | (Micro-)Gravure | (Micro-)Gravure | (Micro-)Gravure & Spray |
| | Electrode application | Anode (Cu) / Cathode (Al) | Cathode (Al) | Anode (Cu) / Cathode (Al) |
| | Active materials | Any | LFP (some NMC) | Any |
| | Coating thickness (dry) | 1 – 2 μm | 1 μm | 5 – 10 μm |
| | Adhesion (Al) | 5B (100%) | 5B (100%) | 5B (100%) |
| Cell Performance | Contact resistance (Ω) | 0.10 – 0.15 | 0.03 – 0.05 | 0.15 – 0.20 |
| | Sheet resistance ($\Omega/\text{sq}/\text{mil}$) | 20 – 30 Ω/sq @1 mil | 10 – 20 Ω/sq @1 mil | 20 – 30 Ω/sq @1 mil |
| | Electrolyte resistance (double rubs) | > 20 | > 100 | > 30 |
| | NMP resistance (double rubs) | n/a | > 100 | > 10 |
| | Electrochemical stability (CV) | 0 – 4.4 V vs. Li/Li ⁺ | 4.4 V vs. Li/Li ⁺ | 0 – 4.4 V vs. Li/Li ⁺ |

CORE HENKEL PRODUCT PORTFOLIO

ENERGY STORAGE MARKET

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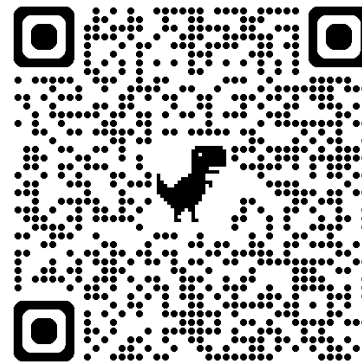


Henkel Adhesive Technologies

WE MAKE
FUTURE MOBILITY
HAPPEN

THANK YOU

Download the Whitepaper!



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